DSG Ansys R&D Meeting Minutes

Date: October 26, 2023 Time: 2:00 PM – 3:00 PM

Attendees: Aaron Brown, Pablo Campero, Brian Eng, Tyler Lemon, and Marc McMullen

1. NPS thermal analysis with Ansys Mechanical

Aaron Brown

- 1. Meshing model with crystal array, cooling plate and dividers
 - Meshing process stops at 5%
 - Ansys support made recommendations
 - Disable the Share Topology option in SpaceClaim software
 - Set bounding contact for all regions in contact
 - Change the physics preference from CFD to Mechanical
 - Applied recommended changes but still stops at 5%
 - Model's geometry and mesh files sent to Ansys support for revision

2. EIC beampipe Ansys Fluent thermal analysis

Pablo Campero

- 1. Set up model materials and boundary conditions in Fluent
 - Included materials for beampipe and insulation
 - Air flowing from left to right with 100°C at the inlet section
- 2. Added three layers of insulation—80 μm of polyimide, 0.1 μm of aluminum, and 80 μm of aerogel
- 3. Re-working the mesh due to issues during first attempt of simulation
 - Monitored velocity and energy residuals
 - Solution in steady mode did not converge after 300 iterations
 - Maximum temperature result for beryllium pipe showed incorrect values > 4500°C

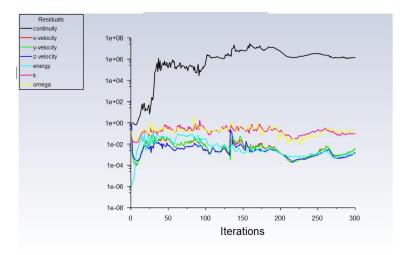


Fig.1. Ansys Fluent residuals monitored during simulation